

Appl. No. 10/817,412
Amdt. dated June 21, 2005
Reply to Office action of May 26, 2005

5 elements.

1 Claim 20 (original): The TM microstrip antenna of claim ~~20~~ ¹⁹ 1/3/06
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2 wherein said copper plated ground mounted on the upper surface of
3 said first dielectric layer is connected to the ground plane
4 mounted on the bottom surface of said second dielectric layer by
5 a plurality of vias which pass from said copper plated ground
6 through said first dielectric layer and said second dielectric
7 layer to said ground plane.